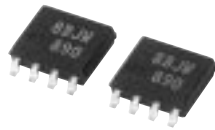


MITSUBISHI Pch POWER MOSFET

FY8ABJ-03

HIGH-SPEED SWITCHING USE

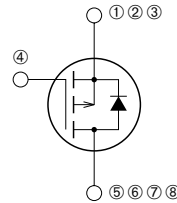
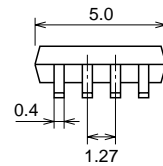
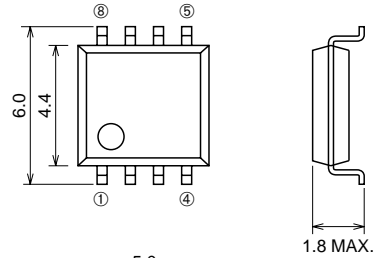
FY8ABJ-03



- 4V DRIVE
- V_{DSS} -30V
- r_{DS (ON)} (MAX) 20mΩ
- I_D -8A

OUTLINE DRAWING

Dimensions in mm



- ① ② ③ SOURCE
- ④ GATE
- ⑤ ⑥ ⑦ ⑧ DRAIN

SOP-8

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (T_c = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	-30	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±20	V
I _D	Drain current		-8	A
I _{DM}	Drain current (Pulsed)		-56	A
I _{DA}	Avalanche drain current (Pulsed)	L = 10μH	-8	A
I _S	Source current		-2.1	A
I _{SM}	Source current (Pulsed)		-8.4	A
P _D	Maximum power dissipation		2.0	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	0.07	g

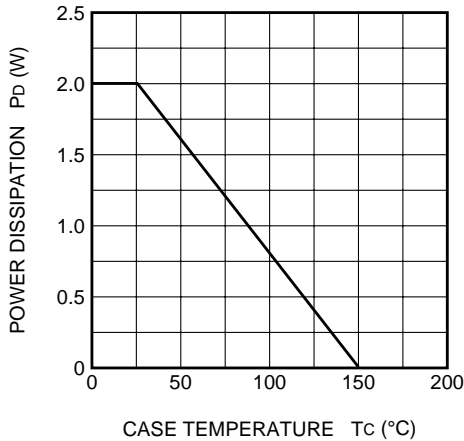
Sep.1998

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

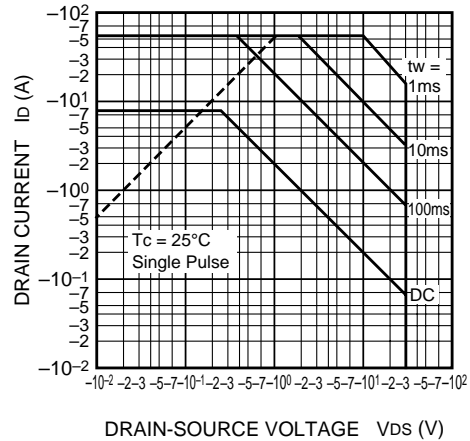
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	ID = -1mA, VGS = 0V	-30	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = -30V, VGS = 0V	—	—	-0.1	mA
VGS(th)	Gate-source threshold voltage	ID = -1mA, VDS = -10V	-1.5	-2.0	-2.5	V
rDS(ON)	Drain-source on-state resistance	ID = -8A, VGS = -10V	—	14	20	mΩ
rDS(ON)	Drain-source on-state resistance	ID = -4A, VGS = -4V	—	26	37	mΩ
VDS(ON)	Drain-source on-state voltage	ID = -8A, VGS = -10V	—	0.112	0.160	V
yfs	Forward transfer admittance	ID = -8A, VDS = -10V	—	19	—	S
Ciss	Input capacitance	VDS = -10V, VGS = 0V, f = 1MHz	—	3650	—	pF
Coss	Output capacitance		—	900	—	pF
Crss	Reverse transfer capacitance		—	385	—	pF
td(on)	Turn-on delay time		—	30	—	ns
tr	Rise time	VDD = -15V, ID = -4A, VGS = -10V, RGEN = RGS = 50Ω	—	55	—	ns
td(off)	Turn-off delay time		—	250	—	ns
tf	Fall time		—	105	—	ns
VSD	Source-drain voltage		IS = -2.1A, VGS = 0V	—	-0.77	-1.20
Rth(ch-a)	Thermal resistance	Channel to ambient	—	—	62.5	°C/W
trr	Reverse recovery time	IS = -2.1A, dis/dt = 50A/μs	—	100	—	ns

PERFORMANCE CURVES

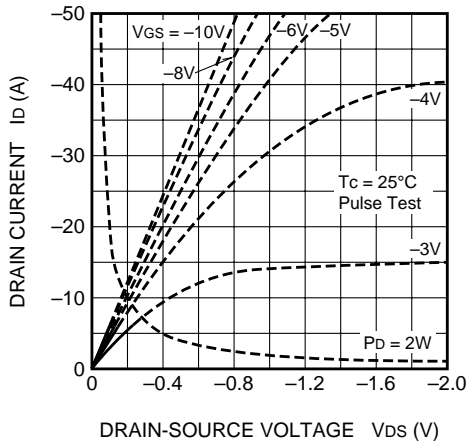
POWER DISSIPATION DERATING CURVE



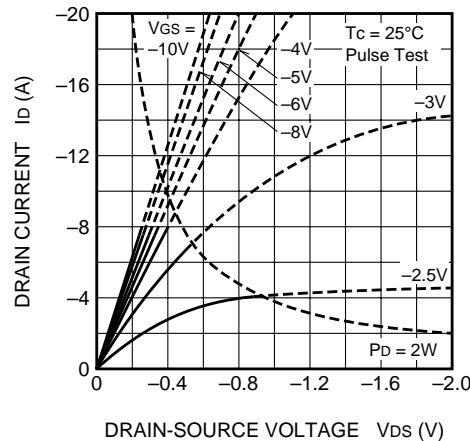
MAXIMUM SAFE OPERATING AREA



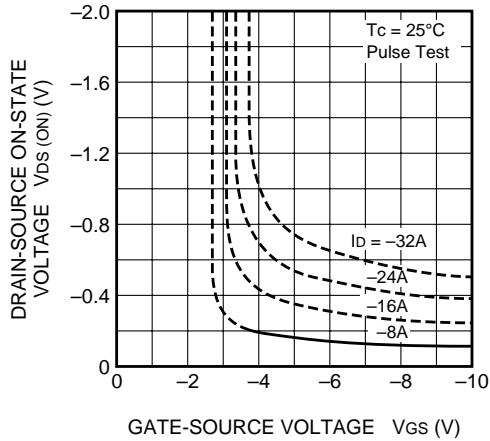
OUTPUT CHARACTERISTICS (TYPICAL)



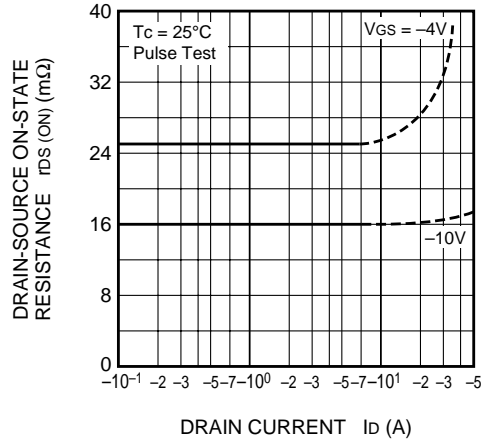
OUTPUT CHARACTERISTICS (TYPICAL)



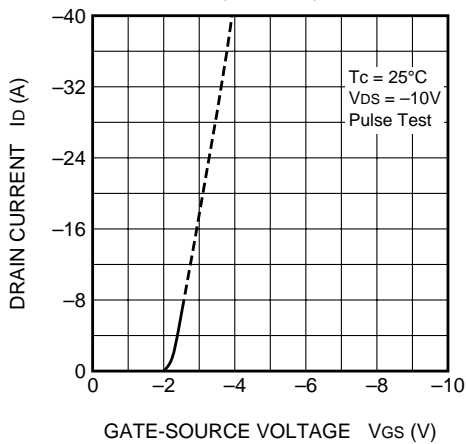
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



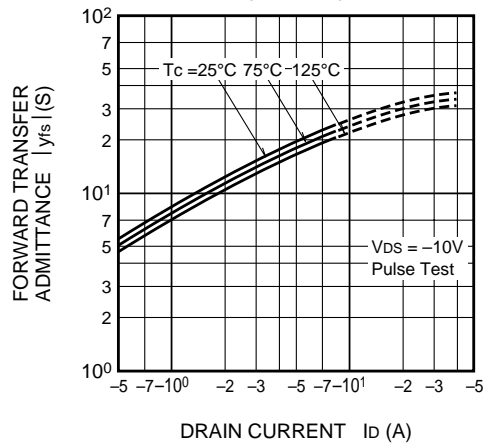
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



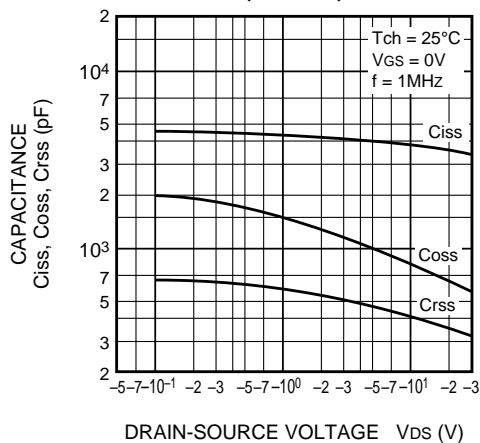
TRANSFER CHARACTERISTICS (TYPICAL)



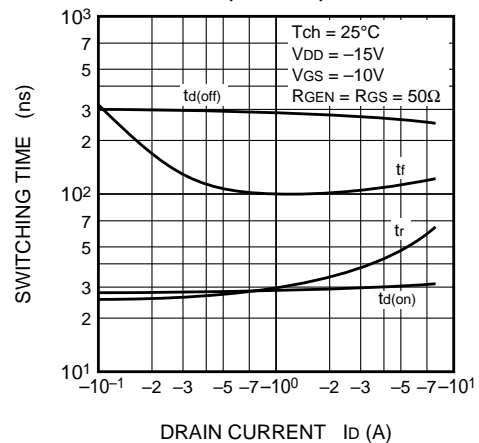
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



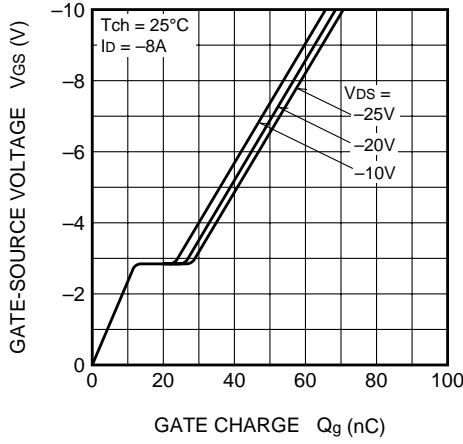
CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



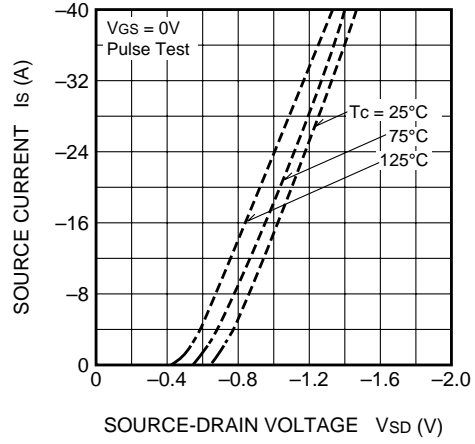
SWITCHING CHARACTERISTICS (TYPICAL)



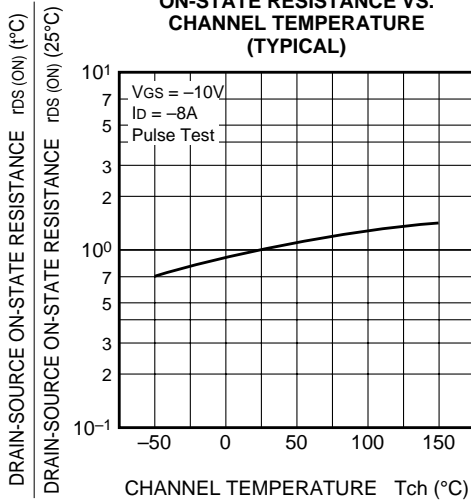
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



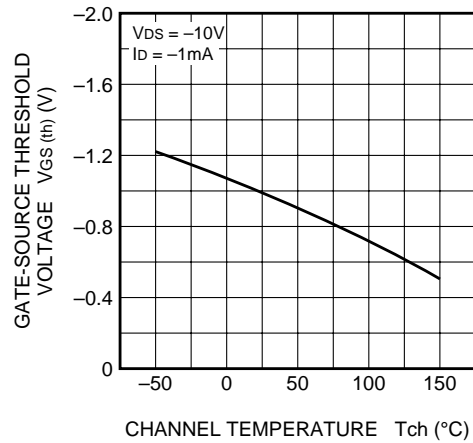
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



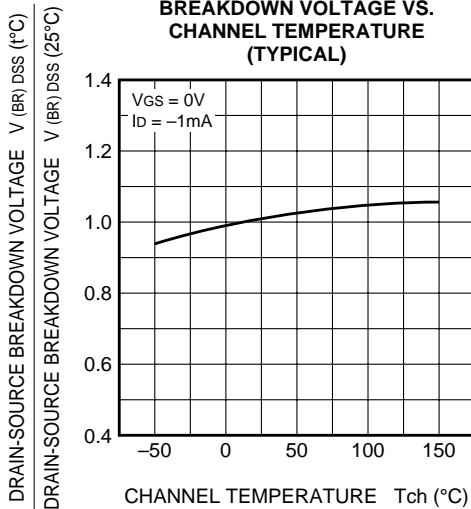
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

